

NCE7580T

NCE N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

The NCE7580T uses advanced trench technology and design to provide excellent $R_{\rm DS(ON)}$ with low gate charge. This device is suitable for use in PWM, load switching and general purpose applications.

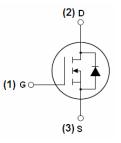
GENERAL FEATURES

- $V_{DS} = 75V, I_D = 80A$ $R_{DS(ON)} < 8mΩ @ V_{GS} = 10V (Typ: 6.5mΩ)$
- Special process technology for high ESD capability
- Special designed for Convertors and power controls
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

100% UIS TESTED! 100% ΔVds TESTED!



Schematic diagram



Marking and pin Assignment



TO-247 top view

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE7580T	NCE7580T	TO-247	-	-	-

Absolute Maximum Ratings (TA=25℃unless otherwise noted)

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Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	75	V
Gate-Source Voltage	V _{GS}	±25	V
Drain Current-Continuous	I _D	80	Α
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	60	А
Pulsed Drain Current	I _{DM}	320	Α
Maximum Power Dissipation	P _D	180	W
Peak diode recovery voltage	dv/dt	30	V/ns
Derating factor		1.2	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	600	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$

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Thermal Characteristic

Thermal Resistance, Junction-to- Case (Note 2)	$R_{ hetaJc}$	0.83	°C/W
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Electrical Characteristics (TA=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA)μA 75		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±25V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	2.85	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =30A	-	6.5	8	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =30A	-	66	-	S
Dynamic Characteristics (Note4)	·					
Input Capacitance	C _{lss}	\/ OF\/\/ O\/	-	4400	-	PF
Output Capacitance	C _{oss}	V_{DS} =25V, V_{GS} =0V, F=1.0MHz	-	340	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UNITZ	-	260	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t _{d(on)}		-	17.8	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, I_D =2A, R_L =15 Ω	-	11.8	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =2.5 Ω	-	56	-	nS
Turn-Off Fall Time	t _f		-	14.6	-	nS
Total Gate Charge	Qg	\/ -24\/ L -40A	-	100	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=24V,I_{D}=40A,$ $V_{GS}=10V$	-	20	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	30	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	80	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 75A	-	35.6	50	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3)		-	56	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

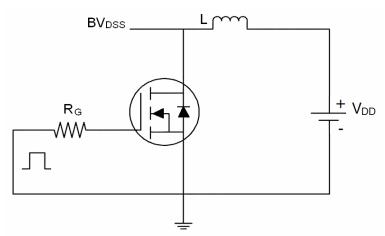
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.3mH, ID=62A

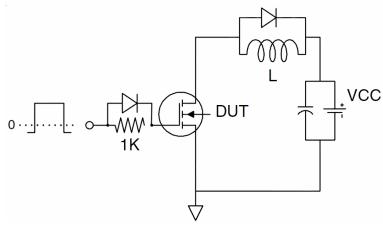
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Test circuit

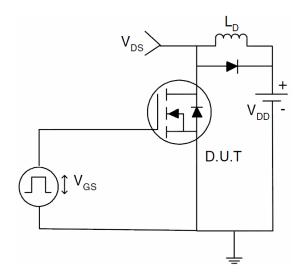
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:



Pb Free Product



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

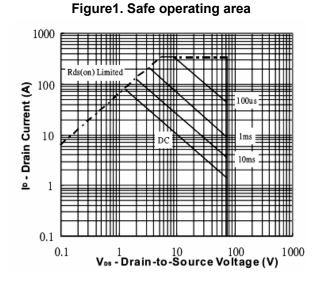


Figure 3. Output characteristics

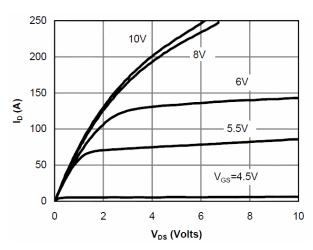


Figure 5. Static drain-source on resistance

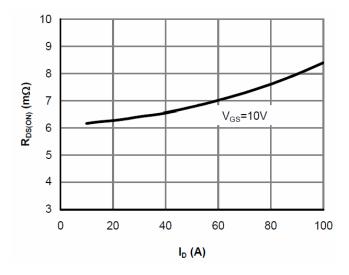


Figure 2. Source-Drain Diode Forward Voltage

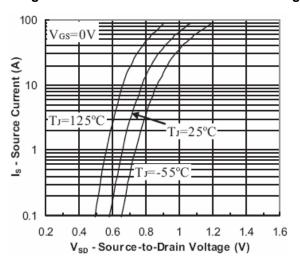


Figure 4. Transfer characteristics

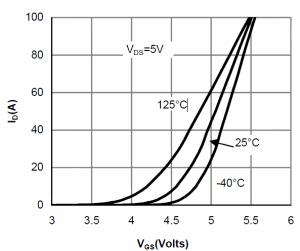


Figure 6. R_{DS(ON)} vs Junction Temperature

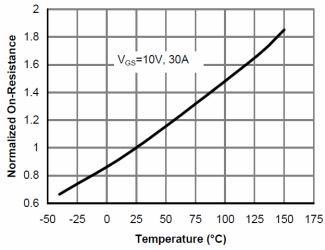




Figure 7. BV_{DSS} vs Junction Temperature

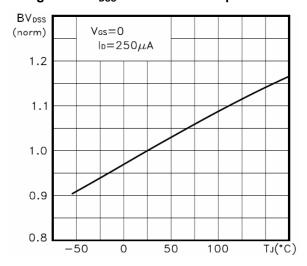


Figure8. V_{GS(th)} vs Junction Temperature

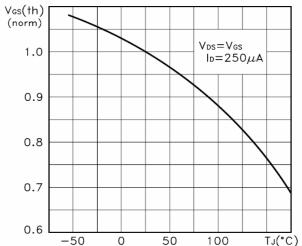


Figure 9. Gate charge waveforms

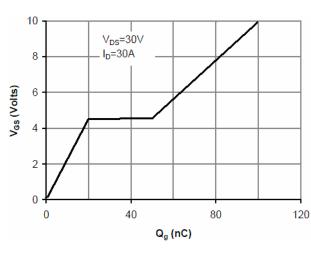
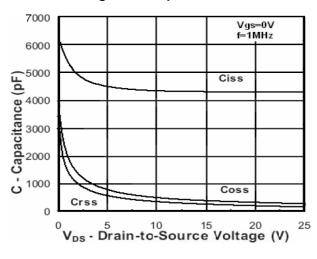
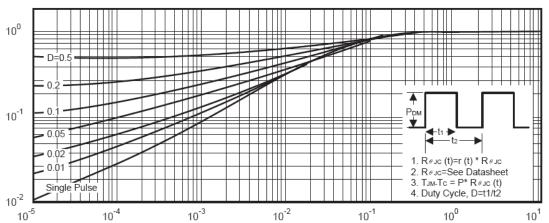


Figure 10. Capacitance







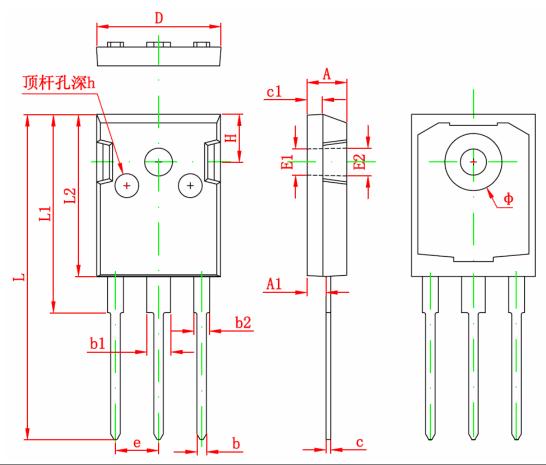
Square Wave Pulse Duration (sec)

Pb Free Product



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TO-247 PACKAGE INFORMATION



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	4.850	5.150	0.191	0.200	
A1	2.200	2.600	0.087	0.102	
b	1.000	1.400	0.039	0.055	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
с	0.500	0.700	0.020	0.028	
c1	1.900	2.100	0.075	0.083	
D	15.450	15.750	0.608	0.620	
E1	3.500REF		0.138REF		
E2	3.600REF		0.142REF		
L	40.900	41.300	1.610	1.626	
L1	24.800	25.100	0.976	0.988	
L2	20.300	20.600	0.799	0.811	
Φ	7.100	7.300	0.280	0.287	
e	5.450TYP		0.215TYP		
Н	5.980TYP		0.235 REF		
h	0.000	0.300	0.000	0.012	



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